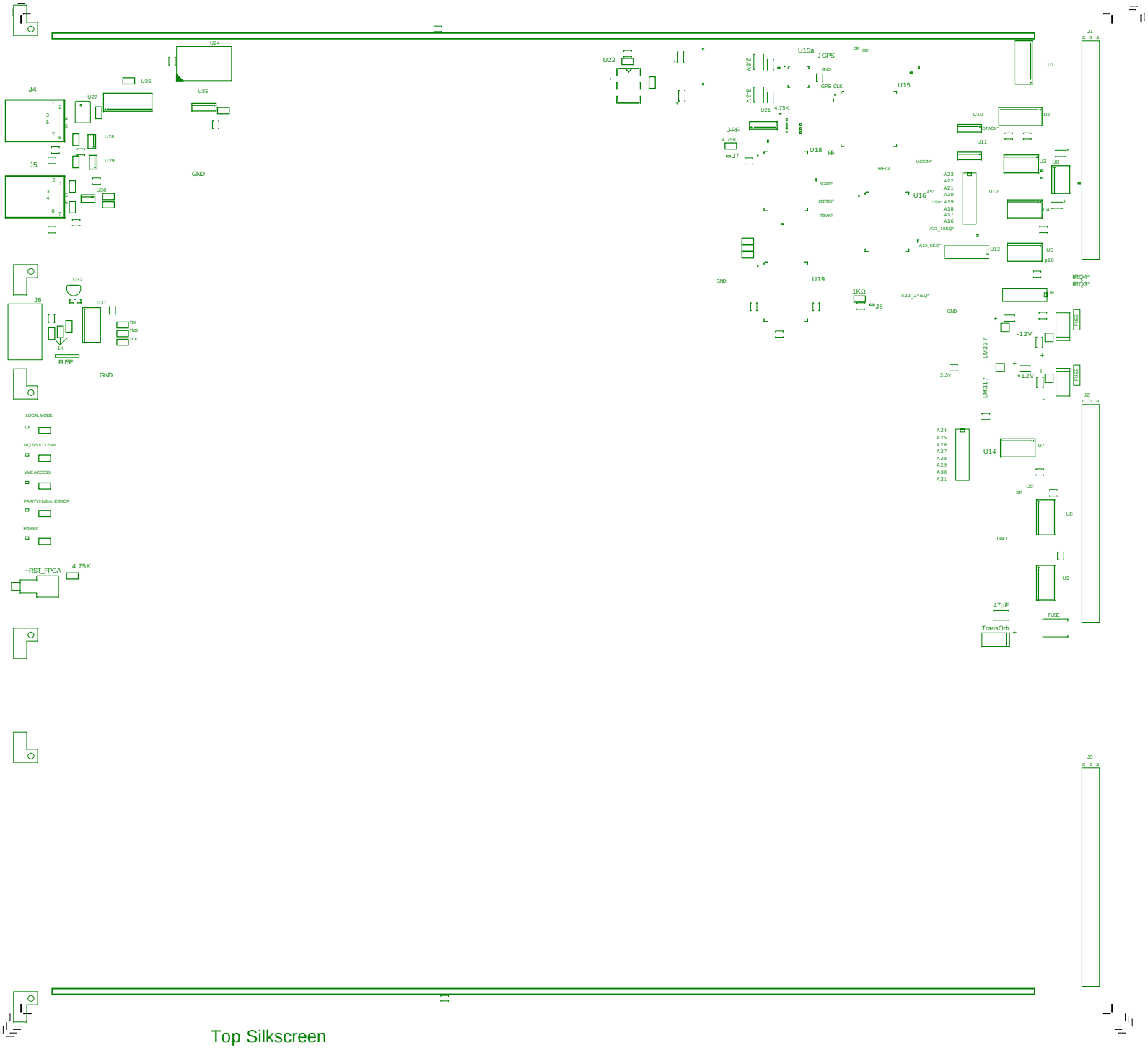
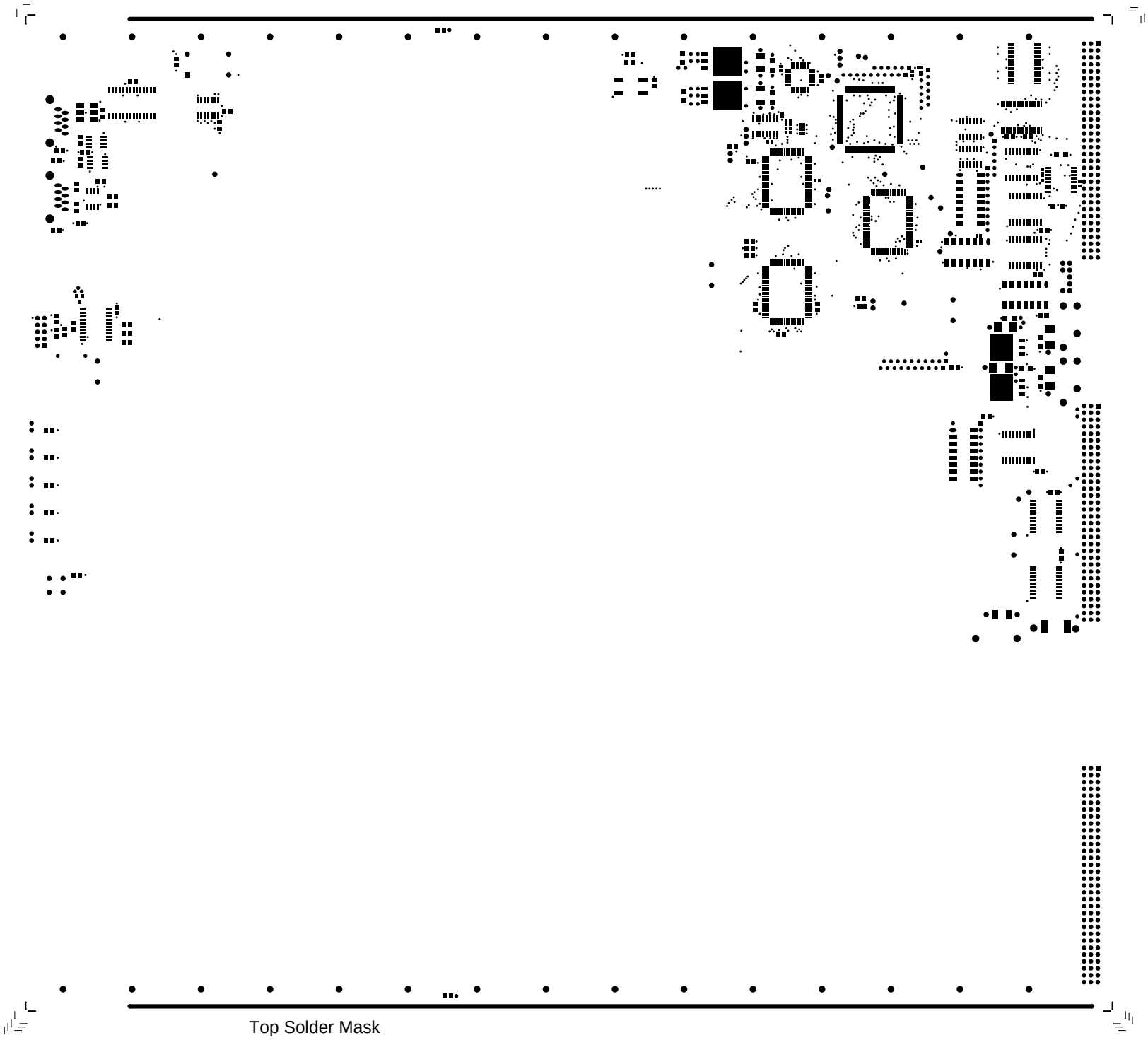
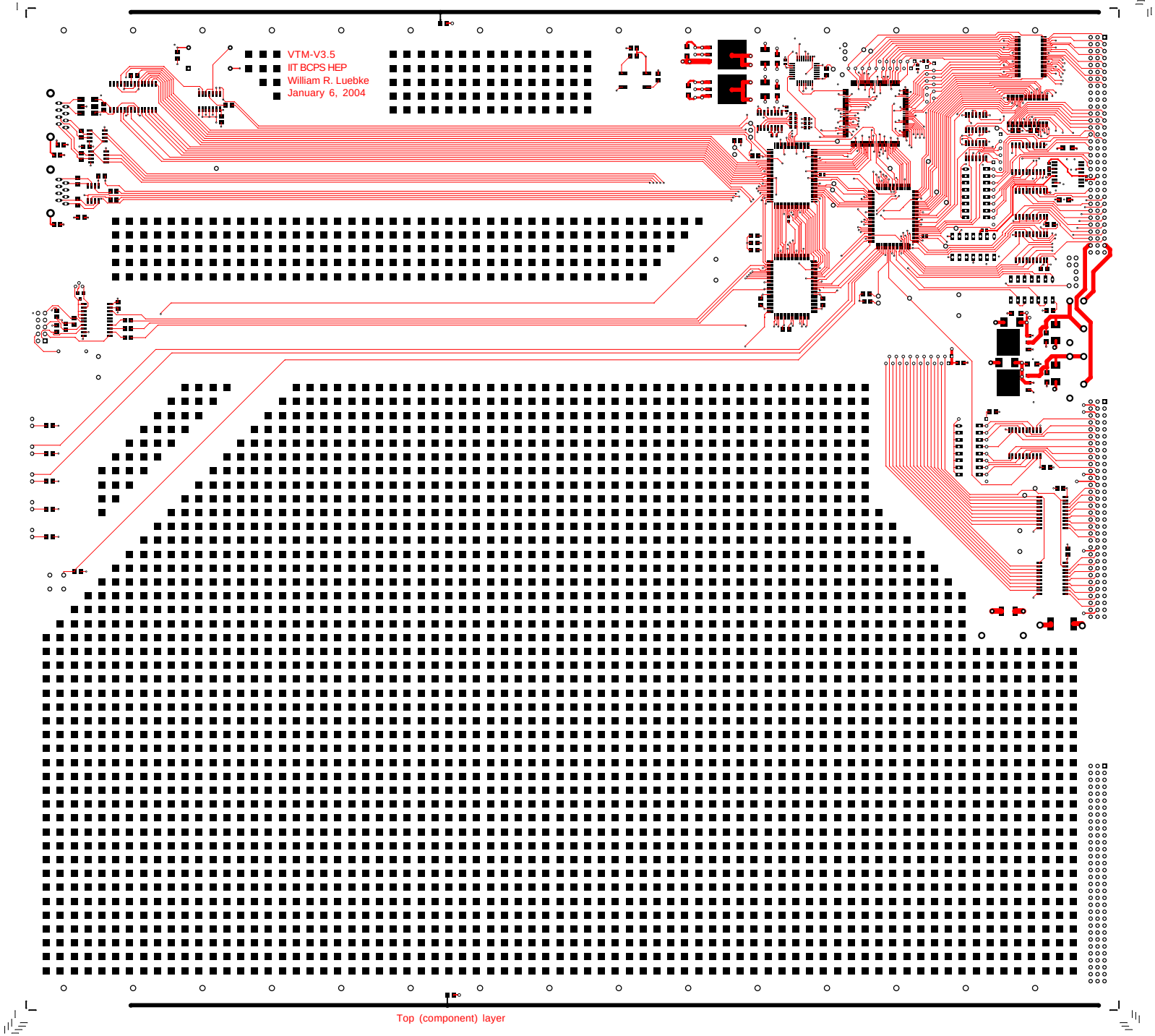
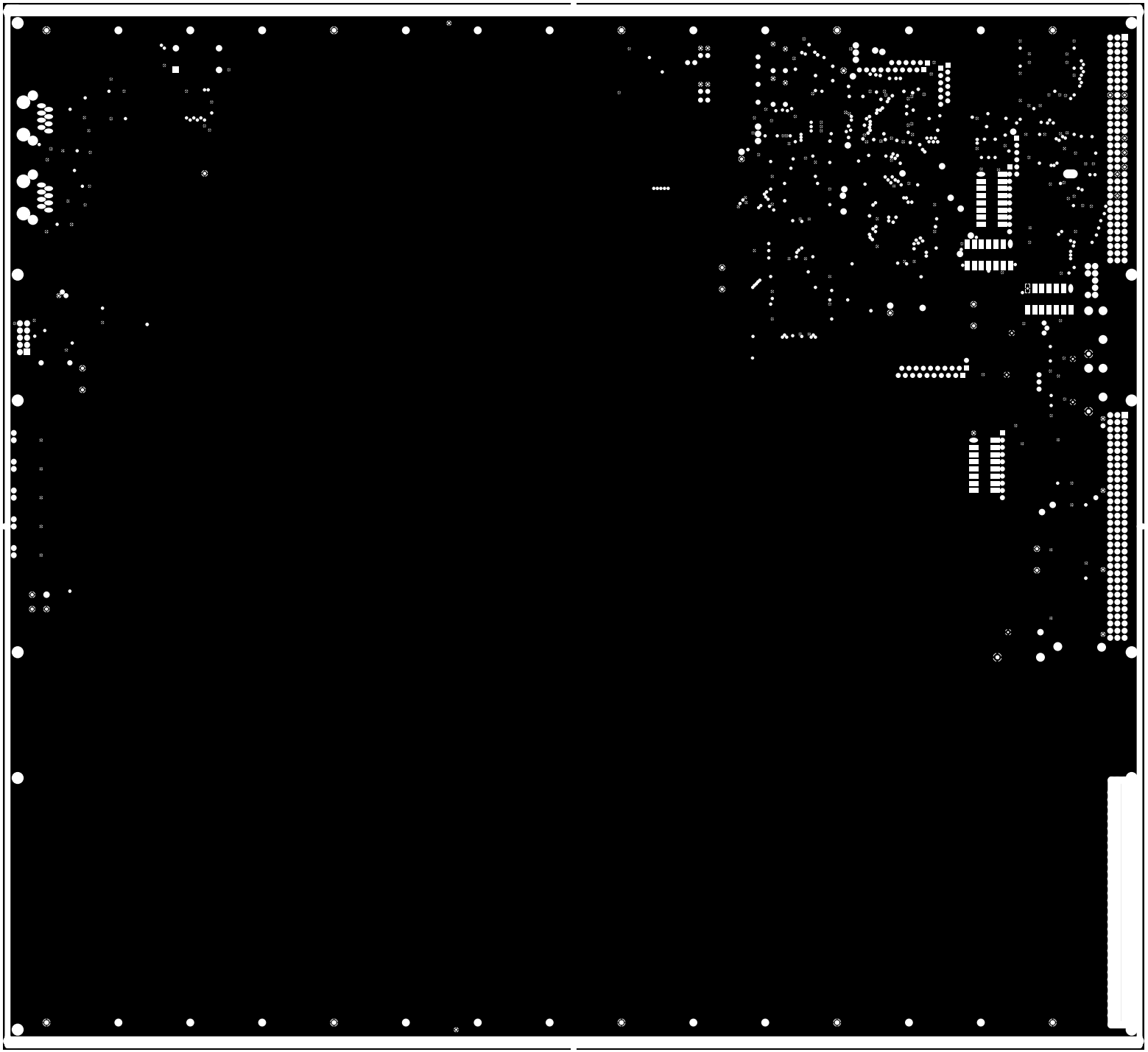


Top Silkscreen

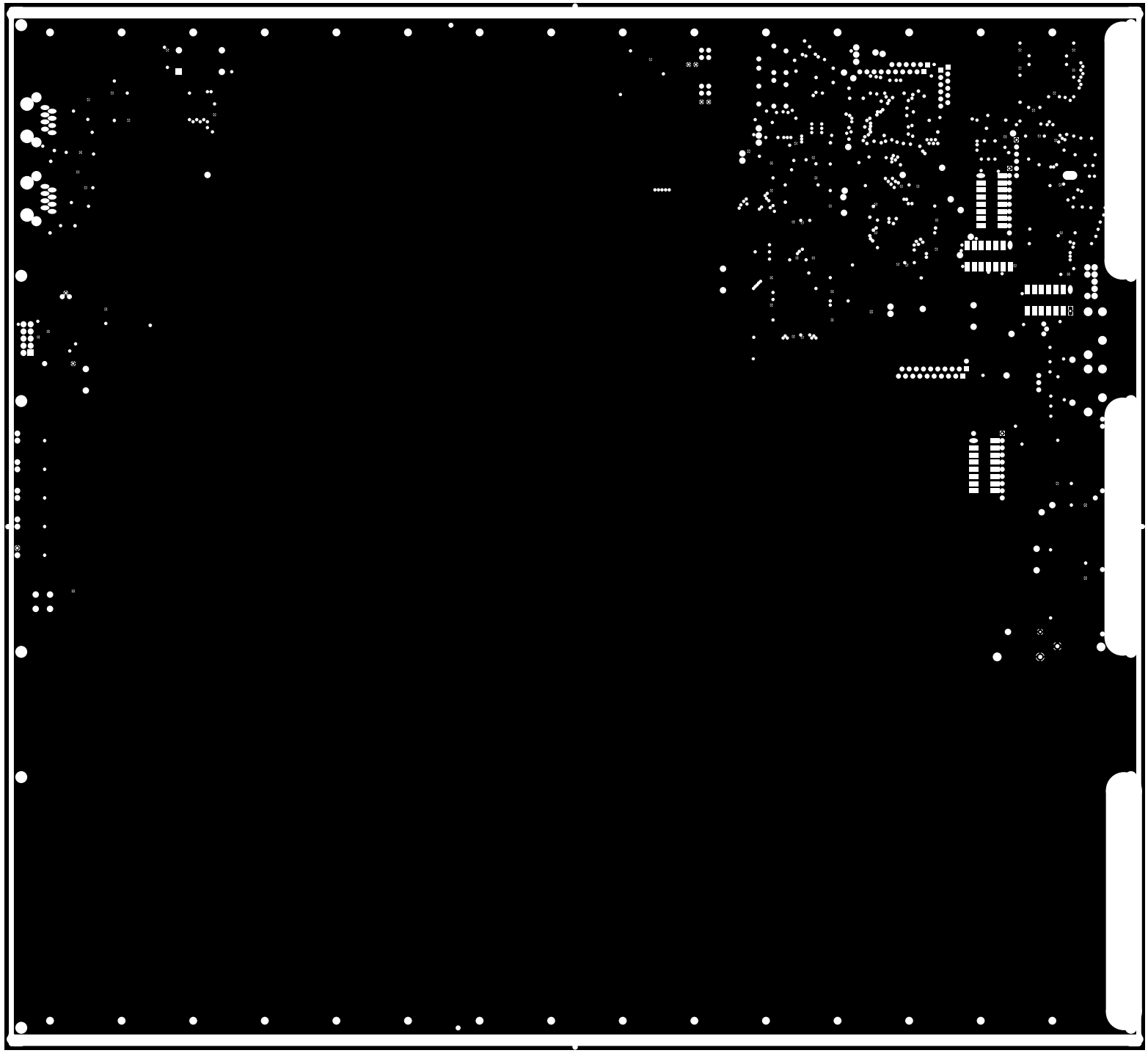


Top Solder Mask

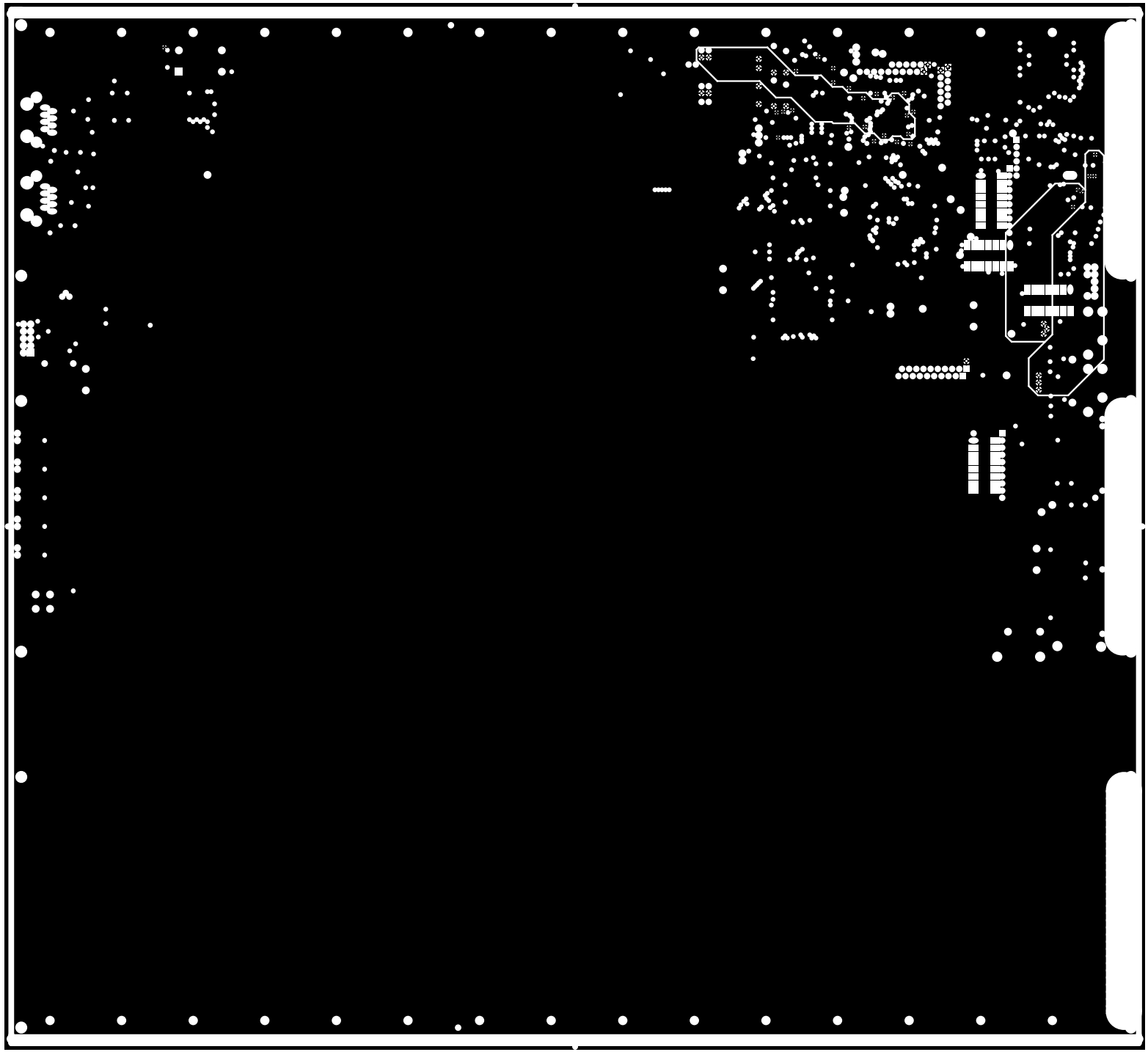

VTM-V3.5
IIT BCPS HEP
William R. Luebke
January 6, 2004
Top (component) layer



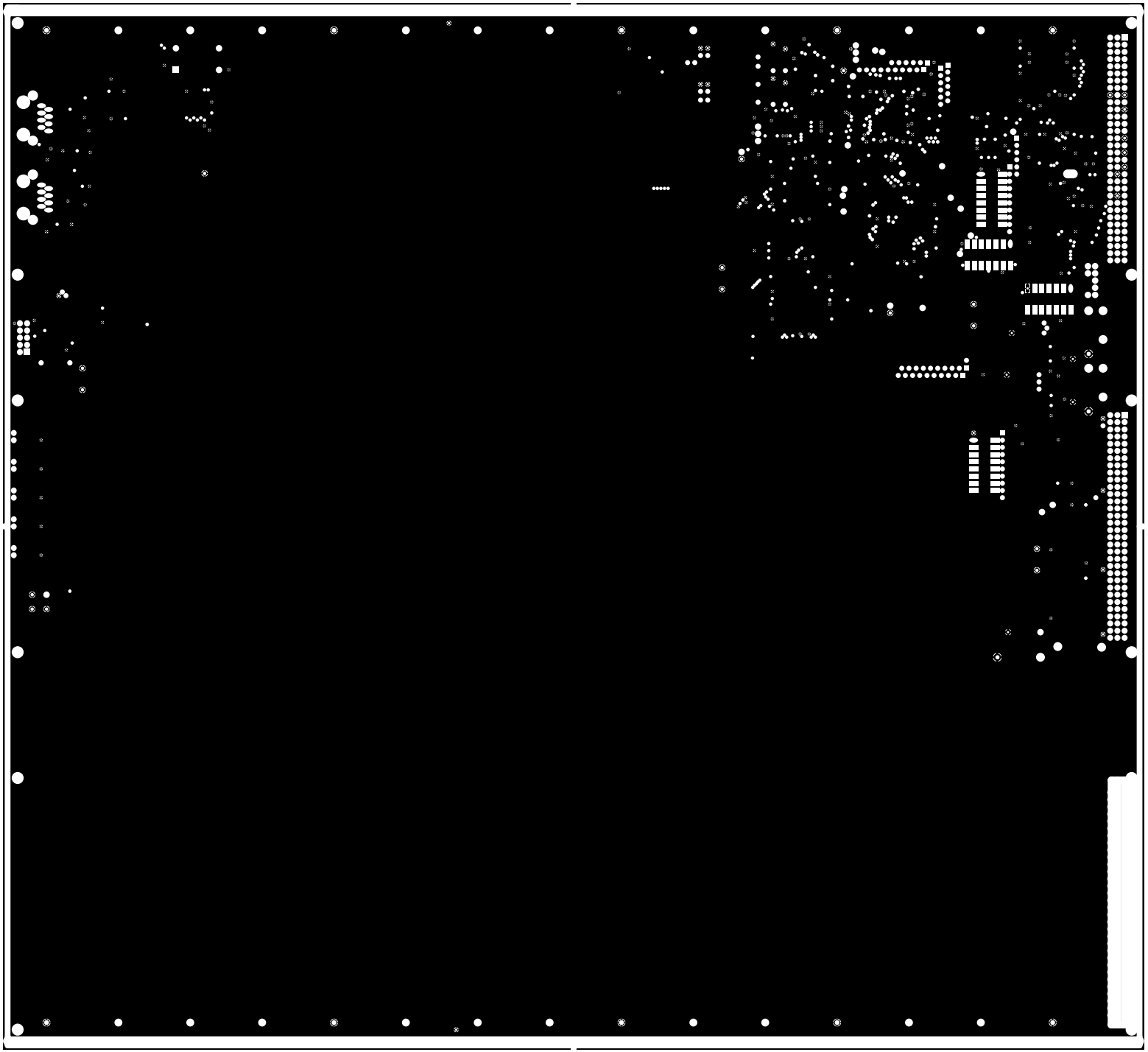
Ground Plane & Ground Thermals



POWER Plane & POWER Thermals



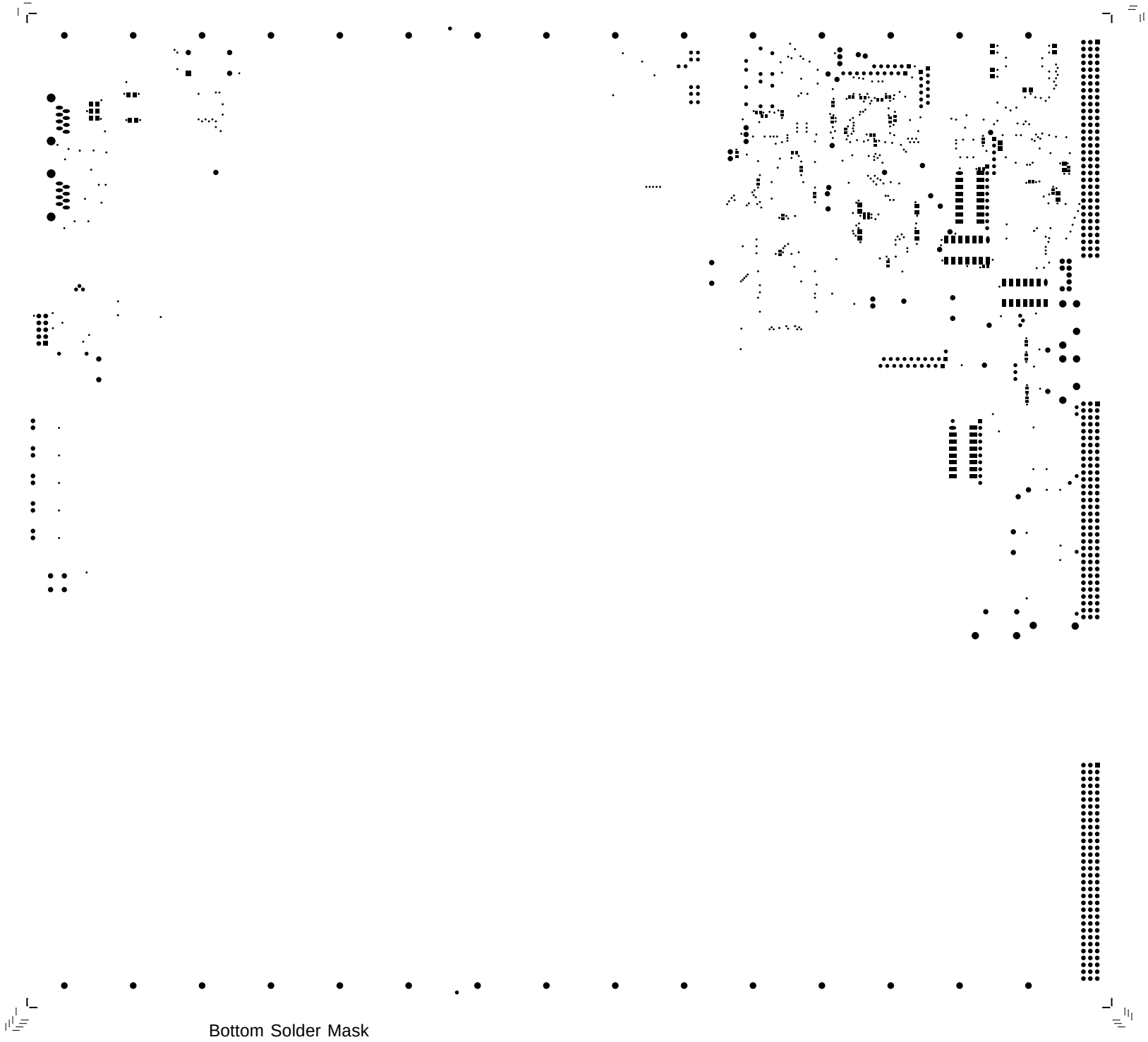
Aux POWER Plane & Aux POWER Thermals



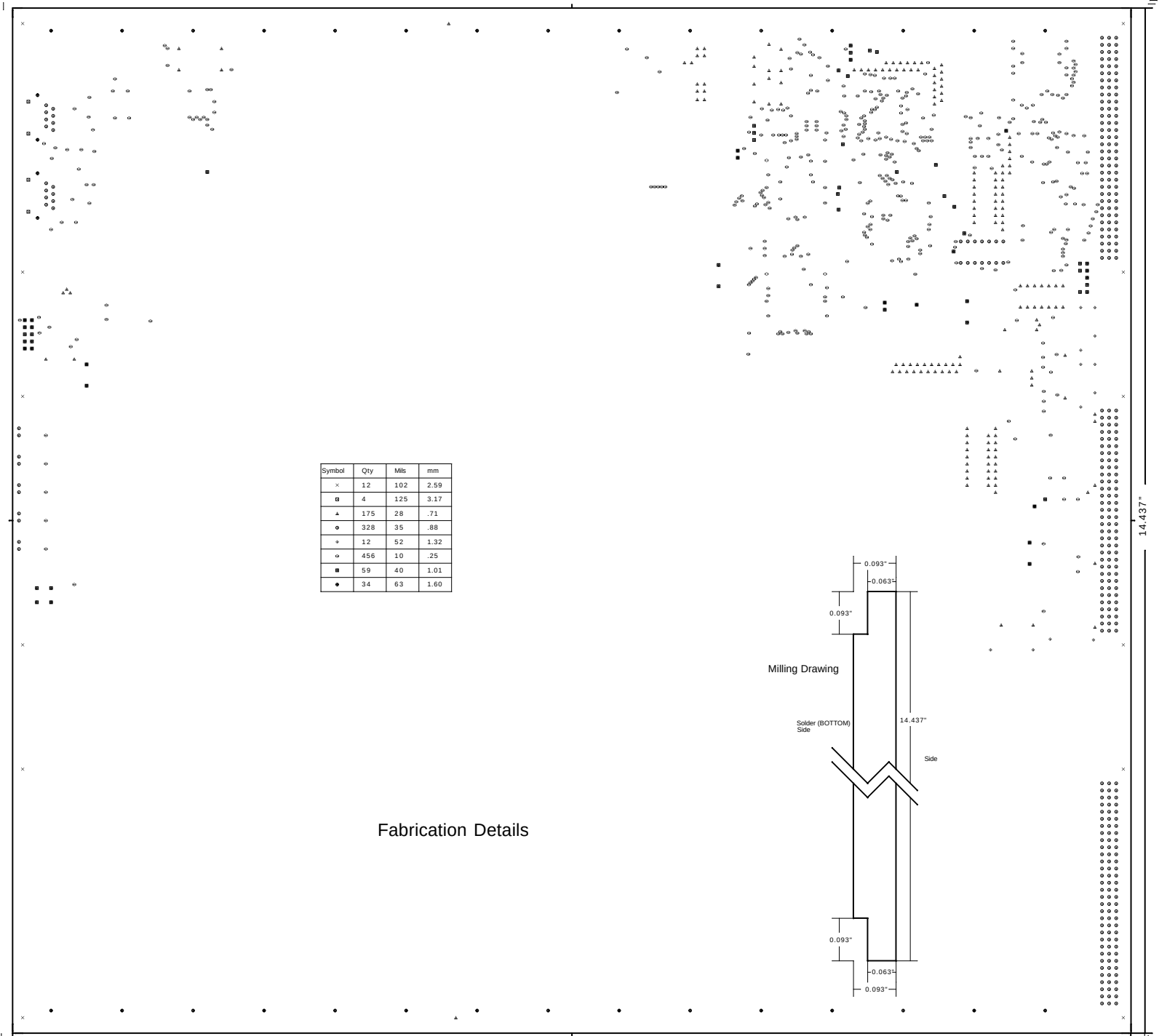
Ground Plane & Ground Thermals

MINOS Clock System
VME Timing Module

Bottom (solder) layer



Bottom Solder Mask



Symbol	Qty	Mils	mm
×	12	102	2.59
▫	4	125	3.17
▵	175	28	.71
⊙	328	35	.88
⌖	12	52	1.32
⊙	456	10	.25
■	59	40	1.01
●	34	63	1.60

Milling Drawing

Solder (BOTTOM) Side

Side

Fabrication Details